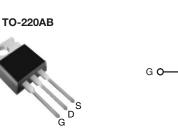


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Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	600				
R _{DS(on)} (Ω)	$V_{GS} = 10 V$	2.2			
Q _g (Max.) (nC)	23				
Q _{gs} (nC)	5.4				
Q _{gd} (nC)	1	1			
Configuration	Single				



N-Channel MOSFET

FEATURES

• Low Gate Charge Q_q Results in Simple Drive Requirement



- Improved Gate, Avalanche and Dynamic dV/dt RoHS COMPLIANT Ruggedness
- Fully Characterized Capacitance and Avalanche Voltage and Current
- Effective Coss Specified
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptable Power Supply
- High Speed Power Switching

TYPICAL SMPS TOPOLOGY

• Single Transistor Flyback

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRFBC30APbF
	SiHFBC30A-E3
SnPb	IRFBC30A
	SiHFBC30A

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	600	v	
Gate-Source Voltage			V _{GS}	± 30	V
Continuous Drain Current	V _{GS} at 10 V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$	- I _D	3.6	
Continuous Drain Current		$T_C = 100 \ ^\circ C$		2.3	А
Pulsed Drain Current ^a		I _{DM}	14	1	
Linear Derating Factor			0.69	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	290	mJ
Repetitive Avalanche Current ^a		I _{AR}	3.6	А	
Repetitive Avalanche Energy ^a		E _{AR}	7.4	mJ	
Maximum Power Dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$		P _D 74		W	
Peak Diode Recovery dV/dt ^c			dV/dt	7.0	V/ns
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	for	10 s		300 ^d	C
Mounting Torque	6-32 or M3 screw			10	lbf ∙ in
Mounting Torque				1.1	N · m

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

- b. Starting $T_J = 25 \text{ °C}$, L = 41 mH, $R_q = 25 \Omega$, $I_{AS} = 3.6 \text{ A}$ (see fig. 12).
- c. $I_{SD} \leq 3.6$ A, dI/dt ≤ 170 A/µs, $V_{DD} \leq V_{DS}$, $T_J \leq 150$ °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RAT	INGS							
PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-		62				
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50		-			°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	- 1.7			-			
SPECIFICATIONS (T _J = 25 $^{\circ}$ C, t	unless otherw	ise noted)						
PARAMETER	SYMBOL	TES	T CONDITIONS	;	MIN.	TYP.	MAX.	UNIT
Static								
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μ	A	600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, $I_D =$	1 mA	-	0.67	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	$V_{GS}, I_{D} = 250 \ \mu$	A	2.0	-	4.5	V
Gate-Source Leakage	I _{GSS}	١	$I_{GS} = \pm 30 \text{ V}$		-	-	± 100	nA
Zara Cata Valtaga Drain Current		V _{DS} =	600 V, $V_{GS} = 0$	V	-	-	25	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 480 V	, V _{GS} = 0 V, T _J =	= 125 °C	-	-	250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 2.2	2 A ^b	-	-	2.2	Ω
Forward Transconductance	9 _{fs}	V _{DS} =	50 V, I _D = 2.2 A	þ	2.1	-	-	S
Dynamic								•
Input Capacitance	C _{iss}		$V_{ee} = 0 V$		-	510	-	
Output Capacitance	C _{oss}	$V_{GS} = 0 V, V_{DS} = 25 V, f = 1.0 MHz, see fig. 5 - 3.$		-	70	-		
Reverse Transfer Capacitance	C _{rss}			3.5	-			
	0		V _{DS} = 1.0 V, f	= 1.0 MHz	-	730	-	pF
Output Capacitance	C _{oss}	$V_{GS} = 0 V$			-	19	-	1
Effective Output Capacitance	C _{oss} eff.	1	$V_{DS} = 0 V t d$	o 480 V ^c	-	31	-	Ì
Total Gate Charge	Qg				-	-	23	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	I _D = 3.6 A, V _D see fig. 6 a		-	-	5.4	nC
Gate-Drain Charge	Q _{gd}	-	300 lig. 0 8		-	-	11	1
Turn-On Delay Time	t _{d(on)}				-	9.8	-	
Rise Time	tr	- .,	000 \/ 1 0.0	٨	_	13	-	
Turn-Off Delay Time	t _{d(off)}		300 V, $I_D = 3.6$ $R_D = 82 \Omega$, see		_	19	-	ns
Fall Time	t _f			-	_	12	-	
Drain-Source Body Diode Characterist	cs							
Continuous Source-Drain Diode Current	Is	integral reverse		3.6				
Pulsed Diode Forward Current ^a	I _{SM}			-	-	14	A	
Body Diode Voltage	V _{SD}	T _J = 25 °C,	, I _S = 3.6 A, V _{GS}	= 0 V ^b	-	-	1.6	V
Body Diode Reverse Recovery Time	t _{rr}	T _ 05 °O I		100 A/ah	-	400	600	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$I_{\rm J} = 25^{-1}$, $I_{\rm F}$	= 3.6 A, dl/dt =	του A/µs ^s	-	1.1	1.7	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time is ne	gligible (turn	-on is do	minated b	by L _S and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

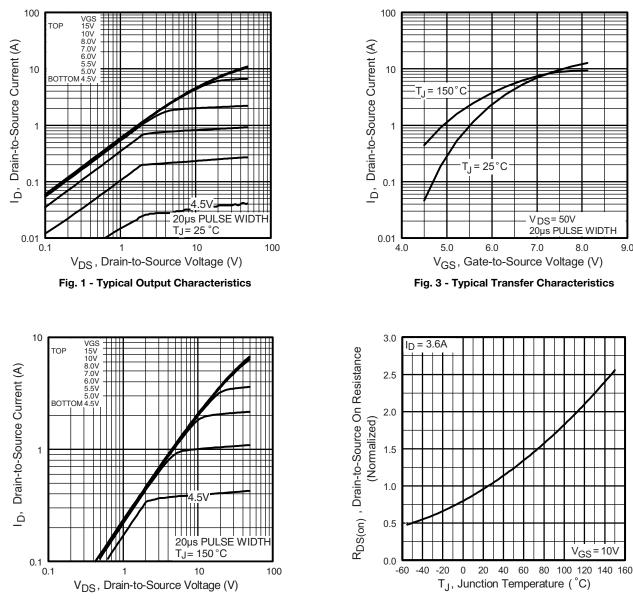
c. C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .

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9.0



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Fig. 2 - Typical Output Characteristics

Fig. 4 - Normalized On-Resistance vs. Temperature

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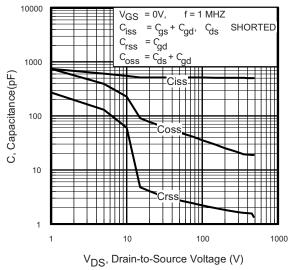


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

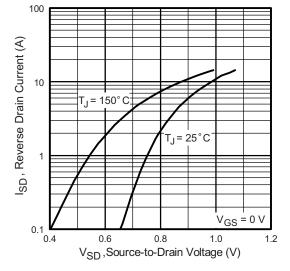


Fig. 7 - Typical Source-Drain Diode Forward Voltage

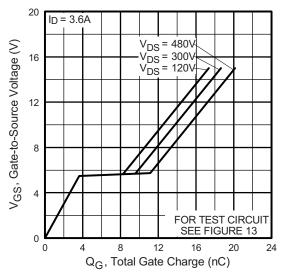


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

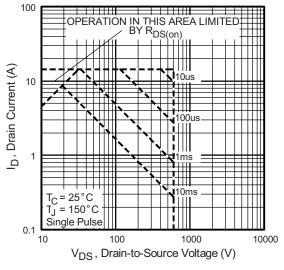
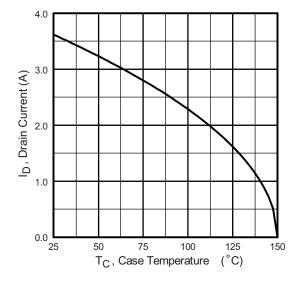


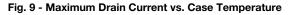
Fig. 8 - Maximum Safe Operating Area

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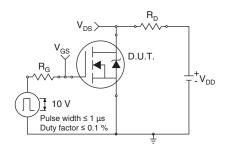


Fig. 10a - Switching Time Test Circuit

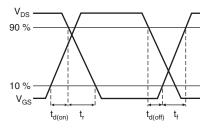
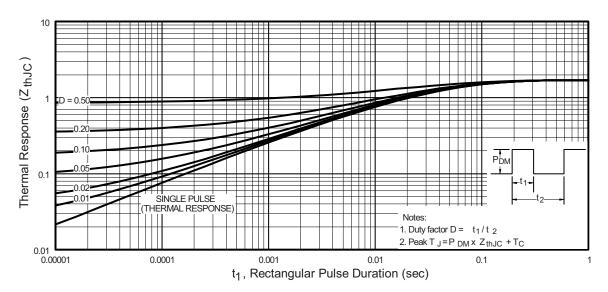
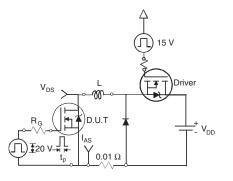
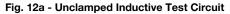


Fig. 10b - Switching Time Waveforms









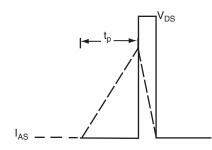
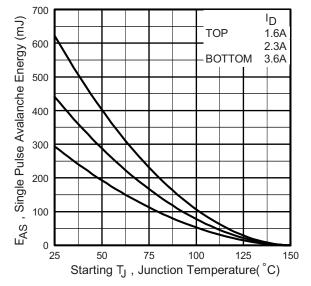


Fig. 12b - Unclamped Inductive Waveforms

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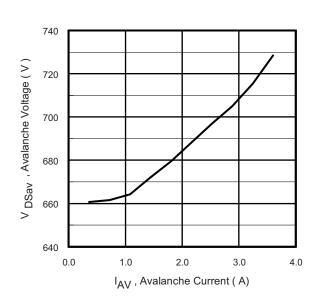
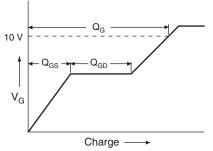


Fig. 12d - Typical Drain-to-Source Voltage vs. Avalanche Current





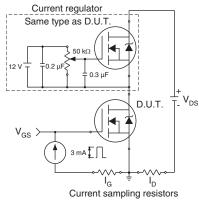
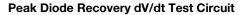


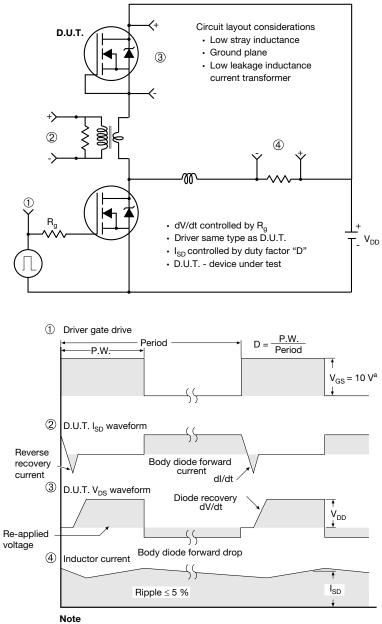
Fig. 13b - Gate Charge Test Circuit

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a. $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

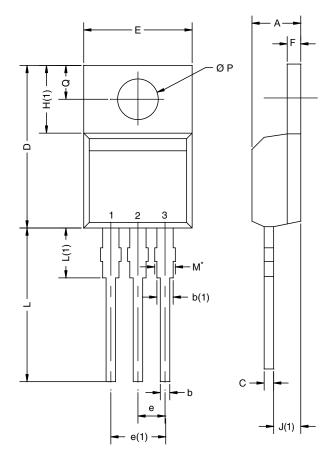
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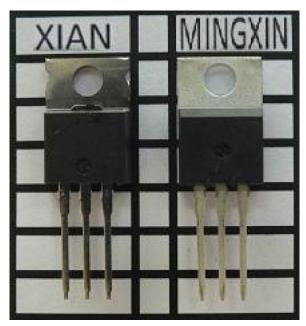


	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN. M		
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
Е	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØР	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	

Notes

 * M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM

Xi'an and Mingxin actual photo



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